



FEATURES

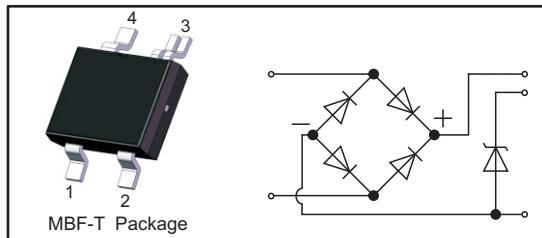
- Lead Free Finish/RoHS Compliant
- Green Molding Compound (No Halogen and Antimony)
- Lower clamping voltage and excellent performance on ringing waves testing.
- Glass Passivated Chip Junction
- High Surge Current Capability
- Designed for Surface Mount Application

PINNING

PIN	DESCRIPTION
1	Input Pin (~)
2	Input Pin (~)
3	Output Anode (+)
4	Output Cathode (-)

MECHANICAL DATA

- Case: MBF-T
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 75mg / 0.0026oz



Maximum Ratings and Thermal Characteristics(TA = 25°C unless otherwise specified)

Ratings at 25 °C ambient temperature unless otherwise specified.

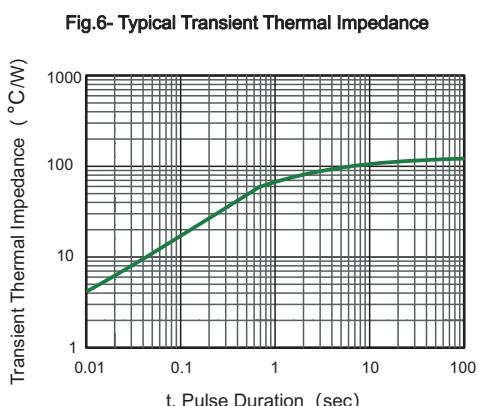
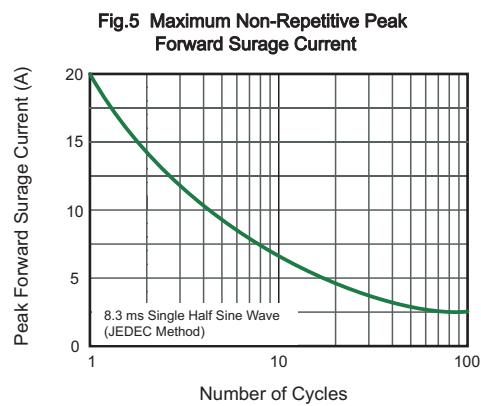
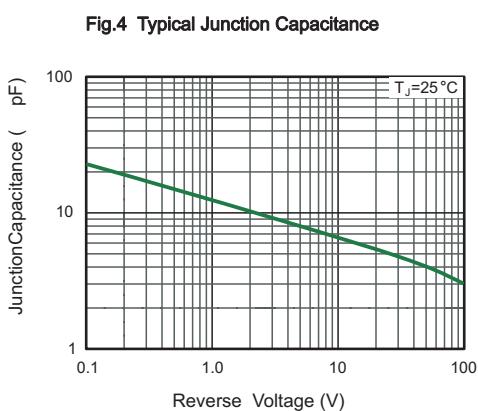
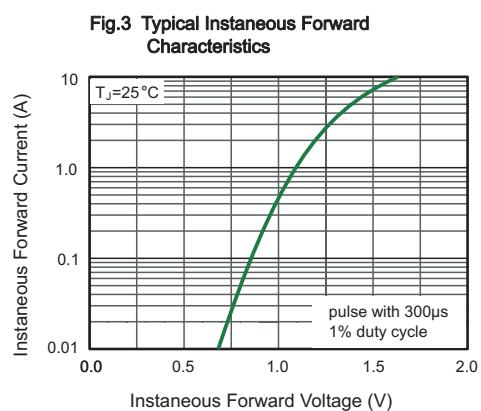
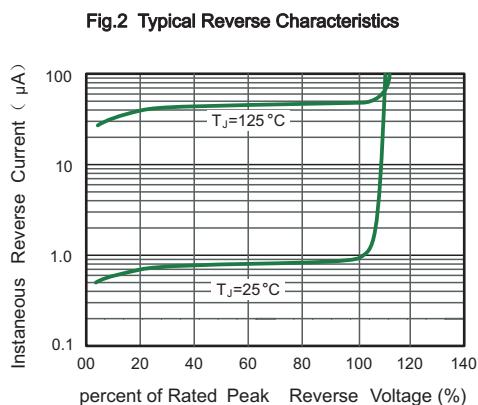
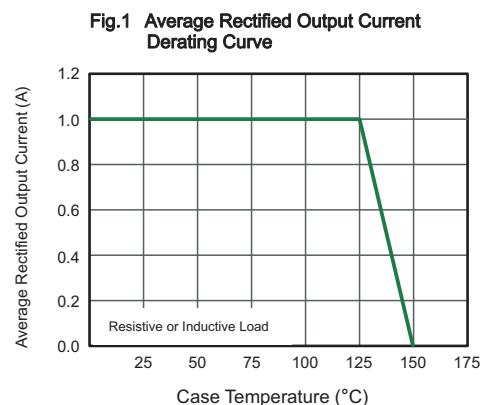
Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter of Bridge Rectifier	Symbols	TB110FB	TB120FB	Units
Average Rectified Output Current at T _C = 125 °C	I _O	1.0		A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I _{FSM}	20		A
Maximum Forward Voltage at 1.0 A	V _F	1.1		V
Maximum DC Reverse Current @T _A =25 °C at Rated DC Blocking Voltage @T _A =125 °C (@VR=1000V)	I _R	5 100		μA
Typical Junction Capacitance (f=1MHz,4V DC)	C _j	8		pF
Typical Thermal Resistance (Note1)	R _{θJA}	130		°C/W
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150		°C

Note: 1. Mounted on glass epoxy PC board with 4×1.5" × 1.5" (3.81 × 3.81 cm) copper pad.

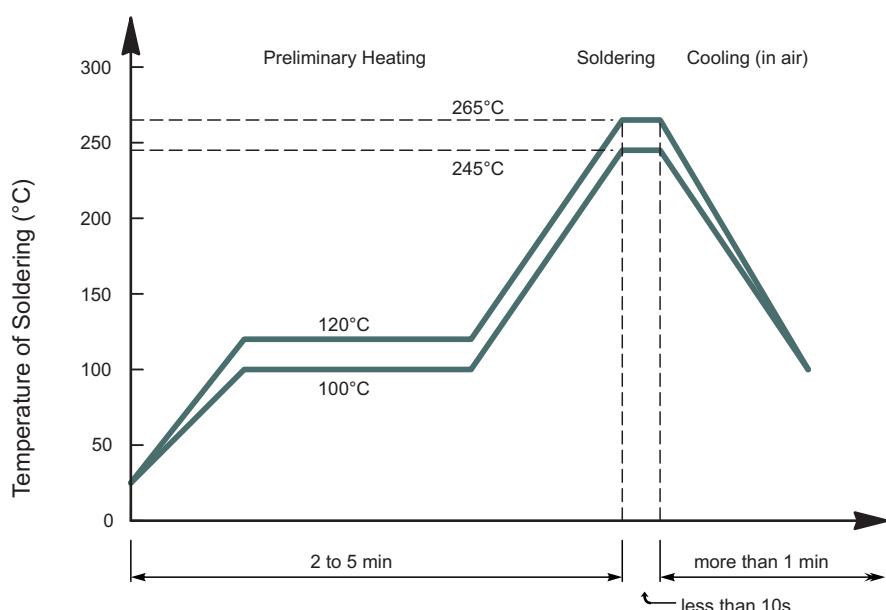
Parameter of TVS	Symbol	TB110FB	TB120FB	Units
Maximum allowable continuous AC voltage at 50-60Hz	V _{RMS}	135	155	V
Breakdown voltage @ 1mA	V _{BR}	209~231	237~263	V
Maximum allowable continuous DC voltage	V _{DC}	190	220	V
Maximum peak current(8/20us@12Ω)(Note2)	I _{peak}	20		A
Operating and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150		°C

Note: 2.The internal resistance of lightning surge generator is 2 Ω, and the series resistance of test circuit is 10 Ω.

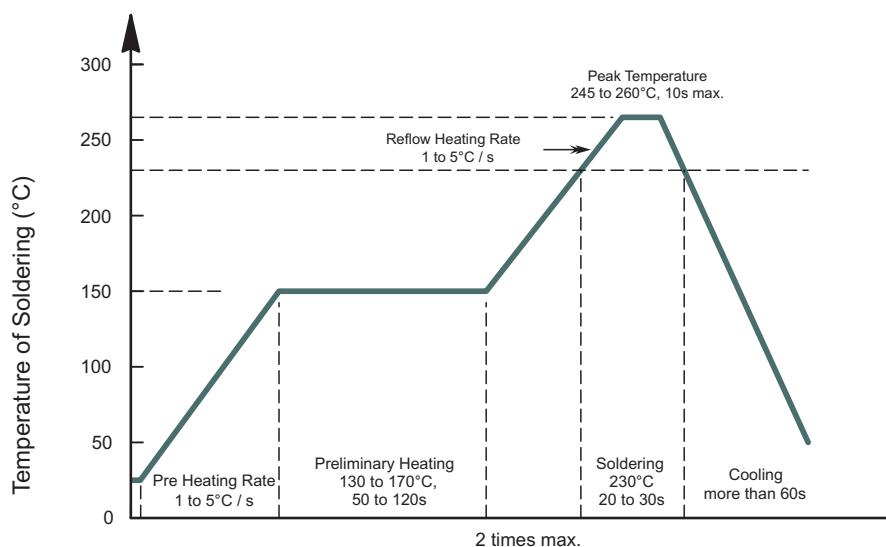




• Recommended condition of flow soldering



• Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters; time length of peak temperature (longer), time length of soldering (longer), thickness of solder paste (thicker)

• Condition of hand soldering

Temperature: 370°C
Time: 3s max.
Times: one time

• Remark:

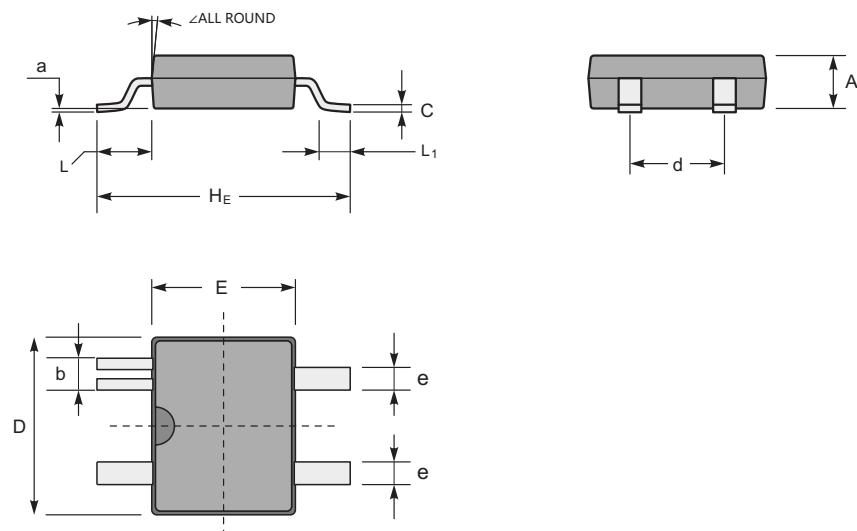
Lead free solder paste (96.5Sn/3.0Ag/0.5Cu)



PACKAGE OUTLINE

Plastic surface mounted package; 5 leads

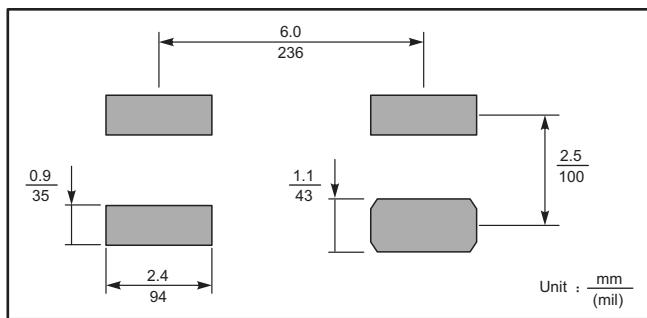
MBF-T



MBF-T mechanical data

UNIT		A	C	D	E	H _E	d	e	L	L ₁	a	b	∠	
mm	max	1.6	0.22	5.0	4.1	7.0	2.7	0.8	1.7	1.1	0.2	0.9	7°	
	min	1.2	0.15	4.5	3.6	6.4	2.3	0.5	1.3	0.5				
mil	max	63	8.7	197	161	276	106	31	67	43	8	35		
	min	47	5.9	177	142	252	91	20	51	20				

The recommended mounting pad size



Marking

Type number	Marking code
TB110FB	TB110FB
TB120FB	TB120FB